# 1.4-MSPS/280-KSPS, ULTRA LOW POWER, 8-BIT, MINIATURE ANALOG-TO-DIGITAL CONVERTER WITH SERIAL INTERFACE

#### FEATURES

- Low power (XC7868 typical):
  0.48mW (3.3V, 280KSPS)
  0.16mW (1.8V, 280KSPS)
- Specified for V<sub>DD</sub> of 1.5V to 4.5V
- High throughput:
  - -1.4 MSPS for 8-Bit  $V_{DD} \ge 3 V$
  - -280 KSPS for 8-Bit  $V_{DD} \ge 1.5 V$
- Automatic power-down
- $\blacktriangleright$  ±0.5LSB INL, ±0.5LSB DNL
- No pipeline delays
- SPI Compatible serial interface
- Second-Source for ADS7868
- 6-Pin SOT-23 Package

#### **APPLICATIONS**

- Battery-powered systems
- Medical instruments
- Remote data acquisition
- Isolated data acquisition
- Automatic test equipment





Figure 1. Functional Block Diagram

#### DESCRIPTION

The XC7868 is an 8-bit ADC (Analog-to-Digital Converter) chip that features ultra-low power, small size, unipolar, and single-ended input. The product operates from a single 1.5V - 4.5V power supply. Adopting advanced technology and design, it has a wide voltage working range: when powered by a single 1.5V - 3V power supply, the sampling rate can reach up to 280 KSPS; When powered by a single 3V - 4.5V power supply, the sampling rate can reach up to 1.4-MSPS.The XC7868 is available in a 6-pin SOT-23 package and has an operating temperature range of -40°C to 85°C.

The XC7868 is second-source for the ADS7868 and consumes only one third dynamic power of their counterpart.

#### **SPECIFICATIONS**

At-40°C to 85°C, fsample = 280 KSPS and fsclk = 3.4 MHz if 1.5 V  $\leq$  Vdd  $\leq$  3.0 V; fsample = 1400 KSPS and fsclk = 16.6 MHz if 3.0 V  $\leq$  Vdd < 4.5 V. (unless otherwise noted)

	TEST CONDITIONS	XC7866			XC7867			XC7868			
PARAMETER		MIN	ТҮР	MAX	MIN	ТҮР	МАХ	MIN	ТҮР	МАХ	UNITS
SYSTEM PERFORMANCE											
Resolution			12			10			8		Bits
No missing codes		12			10			8			Bits
Integral linearity		-1.5		1.5	-0.5		0.5	-0.5		0.5	LSB
Differential linearity		-1.5		1.5	-0.5		0.5	-0.5		0.5	LSB
for up a Throughout rote	fsclk = 3.4 MHz, 1.5 V $\leq$ Vdd $\leq$ 3.0 V			200			240			280	KSPS
ISAMPLE Infoughput rate	fsclk = 16.6 MHz, 3.0 V $\leq$ Vdd $\leq$ 4.5 V			1000			1200			1400	KSPS
SNR	fin = 30 kHz, 1.5 V $\leq$ Vdd < 4.5 V		71.2	5		61.5			49.5		dB
THD	$f_{IN} = 30 \text{ kHz}, 1.5 \text{ V} \le \text{V}_{DD} < 4.5 \text{ V}$		-84			-73			-70		dB

#### XC7868

PARAMETER		TEST CONDITIONS	MIN TYP MAX			UNITS	
IDD Supply current, normal operation	Digital inputs = 0 V or V <sub>DD</sub>	fsample = 280 KSPS, fsclk = 3.4 MHz, Vdd = 3.3 V		145	190		
		fsample = 280 KSPS, fsclk = 3.4 MHz, Vdd = 2.5 V		110	125	μΑ μΑ	
		fsample = 280 KSPS, fsclk = 3.4 MHz, Vdd = 1.8 V		88	102		
		fsample = 100 KSPS, fsclk = 3.4 MHz, Vdd = $3.3$ V		58	69		
		fsample = 100 KSPS, fsclk = 3.4 MHz, Vdd = 2.5 V		39	44		
		fsample = 100 KSPS, fsclk = 3.4 MHz, Vdd = 1.8 V		29	36		
		fsample = 140 KSPS, fsclk = 1.7 MHz, Vdd = $3.3$ V		112	128	μA	
		fsample = 140 KSPS, fsclk = 1.7 MHz, Vdd = 2.5 V		72	78		
			fsample = 140 KSPS, fsclk = 1.7 MHz, Vdd = 1.8 V		58	66	
		fsample = 50 KSPS, fsclk = 1.7 MHz, Vdd = $3.3$ V		41	48	μΑ	
		fsample = 50 KSPS, fsclk = 1.7 MHz, Vdd = 2.5 V		25	28		
		fsample = 50 KSPS, fsclk = 1.7 MHz, Vdd = 1.8 V		21	24		
POWER DISSIPATION,	XC7868						
Normal operation		fsample = 280 KSPS, fsclk = 3.4 MHz, Vdd = 3.3 V		0.48	0.63	mW	
		fsample = 280 KSPS, fsclk = 3.4 MHz, Vdd = 1.8 V		0.16	0.18	mW	
		fsample = 140 KSPS, fsclk = 1.7 MHz, Vdd = 1.8 V			0.10	mW	
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### PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 2. Pin Configuration

TERMINAL		DESCRIPTION				
NAME	NO.	DESCRIPTION				
REF/V <sub>DD</sub>	1	External reference input and power supply.				
GND	2	Analog Ground. All analog input signals should be referred to this GND voltage.				
VIN	3	Analog Input. Single-ended analog input channel. The input range is 0 V to $V_{\text{DD}}$ .				
SCLK	4	Serial clock input. This clock is used for clocking data out, and it is the source of conversion clock.				
SDO	5	This is the serial data output of the conversion result. The serial stream comes with MSB first.				
CS	6	Chip Select. Active low logic input. This input provides the dual function of initiating conversions on the				
	0	devices and frames the serial data transfer.				

#### TIMING DIAGRAM



#### Figure 3. Timing Diagram

On the  $\overline{\text{CS}}$  falling edge, the part begins to power up and the track-and-hold, which was in hold while the part was in power-down, goes into track mode. The conversion is also initiated at this point. On the third SCLK falling edge after the  $\overline{\text{CS}}$  falling edge, the track and-hold returns to hold mode. Although  $\overline{\text{CS}}$  can idle high or low between conversions, bringing  $\overline{\text{CS}}$  high once the conversion is complete is recommended to save power. At 12 falling edges of the SCLK, the SDO enters three-state and the conversion cycle ends.

### TYPICAL CONNECTION

For a typical connection circuit for the XC7868 see Figure 4. The 1.8 V supply should come from a stable power supply such as an LDO. A 1- $\mu$ F and a 10-nF decoupling capacitor are required between the V<sub>DD</sub> and GND pins of the converter. This capacitor should be placed as close as possible to the pins of the device. Designers should strive to minimize the routing length of the traces that connect the terminals of the capacitor to the pins of the converter.



Figure 4. Typical Circuit Configuration

## **CONVERSION RESULTS**

DESCRIPTION		DIGITAL OUTPUT STRAIGHT BINARY				
DESCRIPTION	ANALOG INPUT VOLTAGE	BINARY CODE	HEX CODE			
XC7868 (8bit)						
Least Significant Bit (LSB)	V <sub>DD</sub> /256					
Full Scale	V <sub>DD</sub> – 1LSB	1111 1111	FF			
Mid Scale	V <sub>DD</sub> /2	1000 0000	80			
Mid Scale – 1LSB	V <sub>DD</sub> /2 – 1LSB	0111 1111	7F			
Zero	0V	0000 0000	00			

The MSB of the converted result follows 4 leading zeros. When supplies are first applied to the devices, a dummy conversion should be performed to ensure that the parts are in power-down mode, the track-and-hold is in hold mode, and SDO is in three-state. Once a data transfer is complete (SDO has returned to three-state), another conversion can be initiated after the quiet time, has elapsed, by bringing  $\overline{CS}$  low again.

#### **OUTLINE DIMENTIONS**



#### NOTES

1. Unpacked ICs, tube-mounted ICs, etc. must be stored in a drying cabinet, and the humidity in the drying cabinet < 20% R.H.

2. After access, the components are stored in an electrostatic packaging protective bag.

3. Anti-static damage: the device is an electrostatic sensitive device, and sufficient anti-static measures should be taken during transmission, assembly and testing.

4. The user should conduct a visual inspection before use, and the bottom, side and surrounding of the circuit can be welded only if it is bright. If oxidation occurs, the circuit can be processed by means of oxidation, and the circuit must be soldered within 12 hours after processing.